



# **Thin Film, Top-Contact Megohm Resistor**



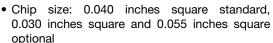
Product may not be to scale

The SFX series resistor chips extends the range of available resistance to 20  $M\Omega$  These offer one of the best combinations of small size and high value available.

The SFXs are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The SFXs are 100 % electrically tested and visually inspected to MIL-STD-883, method 2032 class H or class K.

#### **FEATURES**

- Wire bondable
- Megohm resistance range: 0.36 M $\Omega$  to 30 M $\Omega$



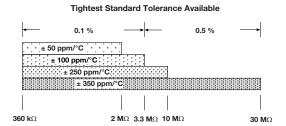


- Case: 0303, 0404, 0505
- · Reduced hybrid size
- · Resistor material: tantalum nitride, self-passivating
- · Oxidized silicon substrate
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

The SFX series megohm resistor chips are designed for use in hybrid packages which require small-size high-value resistors.

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES		
PARAMETER	VALUE	UNIT
Total Resistance Range	360K to 30M	Ω
Standard Tolerances	± 0.1, ± 0.5	%
TCR	± 50, ± 100, ± 250, ± 350	ppm/°C



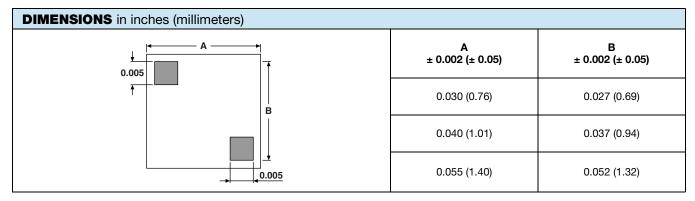
SIZE (in inches)	MIN.	MAX.
0.030 x 0.030	360 kΩ	10 MΩ
0.040 x 0.040	510 kΩ	20 ΜΩ
0.055 x 0.055	1 ΜΩ	30 MΩ

STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER	VALUE	UNIT
Noise, MIL-STD-202, Method 308	-12 typ.	dB
Moisture Resistance, MIL-STD-202 Method 106, (Passivated only)	± 0.5 max. Δ <i>R/R</i>	%
Stability, 1000 h, +125 °C, 10 mW	± 1.0 max. Δ <i>R</i> / <i>R</i>	%
Operating Temperature Range	-55 to +125	°C
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	$\pm$ 0.25 max. $\Delta R/R$	%
High Temperature Exposure, +150 °C, 100 h	$\pm$ 0.5 max. $\Delta R/R$	%
Dielectric Voltage Breakdown	400	V
Insulation Resistance	10 <sup>12</sup> min.	Ω
Operating Voltage	100 max.	V
DC Power Rating at +70 °C (Derated to zero at +175 °C)	0.020	W
5x Rated Power Short-Time Overload, +25 °C, 5 s	± 0.25 max. Δ <i>R/R</i>	%





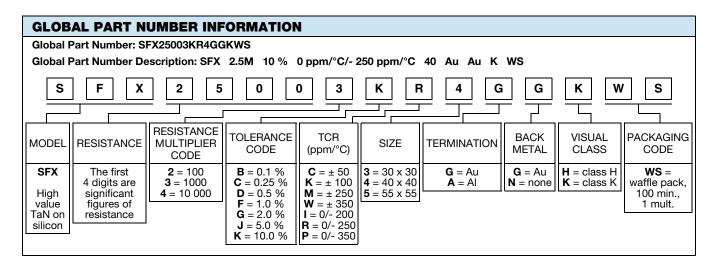
## Vishay Electro-Films



#### **SCHEMATIC**



MECHANICAL SPECIFICATIONS		
PARAMETER	VALUE	
Chip Size	Per table above	
Chip Thickness	0.010" ± 0.002" (0.254 mm ± 0.050 mm)	
Chip Substrate Material	Oxidized silicon, 10 kÅ minimum SiO <sub>2</sub>	
Resistor Material	Tantalum nitride, self-passivating	
Bonding Pad Size	0.005" x 0.005" (0.127 mm x 0.127 mm)	
Number of Pads	2	
Pad Material	10 kÅ minimum aluminum (gold pads available)	
Backing	None, lapped semiconductor silicon (gold back available)	





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